

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	UNBENDING PRINTED CIRCUIT BOARD
<p>Application Number :</p> <p>Date :</p> <p>First Named Applicant: Chun-Yang Lin</p> <p>Confirmation Number:</p> <p>Attorney Docket Number: ACMP0164USA</p>	
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Winston Hsu Registered Number: 41,526	/Winston Hsu/

Documents being submitted:	Files
us-power-of-attorney-grant	ACMP0164-0-A1-uspoat.xml us-power-of-attorney-grant.dtd us-power-of-attorney-grant.xsl
us-assignment	ACMP0164-0-A1-usassn.xml us-assignment.xsl us-assignment.dtd ACMP0164-0-A1ASS1.tif ACMP0164-0-A1ASS2.tif
us-request	ACMP0164-0-A1-usrequ.xml us-request.dtd us-request.xsl
us-declaration	ACMP0164-0-A1-usdecl.xml us-declaration.dtd us-declaration.xsl
us-fee-sheet	ACMP0164-0-A1-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
application-body	ACMP0164-0-A1-ABX.xml application-body.dtd Image1.tif Image2.tif Image3.tif Image4.tif Image5.tif isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isogr1.ent isogr2.ent isogr3.ent isogr4.ent isolat1.ent isolat2.ent isomfrk.ent isomopf.ent isomscr.ent isonum.ent isopub.ent isotech.ent mathml2.dtd mathml2-qname-1.mod mmlalias.ent

	mmlextra.ent
	soextbx.dtd
	us-application-body.xsl
	wipo.ent
application-body-pdf-wrap	ACMP0164-0-A1-ABX-pdf-wrap.xml
abstract-pdf	ACMP0164-0-A1-ABX-abst.pdf
claims-pdf	ACMP0164-0-A1-ABX-clms.pdf
description-pdf	ACMP0164-0-A1-ABX-desc.pdf
drawings-pdf	ACMP0164-0-A1-ABX-draw.pdf
us-declaration	ACMP0164-0-A1DEC1.tif
us-declaration	ACMP0164-0-A1DEC2.tif
us-declaration	ACMP0164-0-A1DEC3.tif
us-declaration	ACMP0164-0-A1DEC4.tif
us-declaration	ACMP0164-0-A1DEC5.tif

Comments